

Description

The SX60N02NF uses advanced trench technology to provide excellent $R_{DS(ON)}$, low gate charge and operation with gate voltages as low as 2.5V. This device is suitable for use as a Battery protection or in other Switching application.

General Features

$V_{DS}=20V$ $I_D=60A$

$R_{DS(ON)} < 6.0m\Omega$ @ $V_{GS}=4.5V$

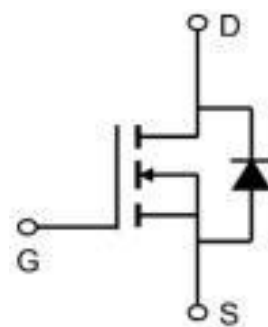
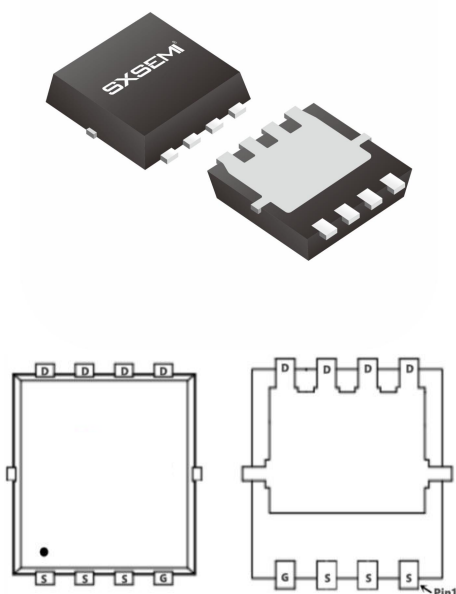
Application

Battery protection

Load switch

Uninterruptible power supply

PDFN5*6-10L



Absolute Maximum Ratings (TC=25°C unless otherwise noted)

Symbol	Parameter	Max.	Units
VDSS	Drain-Source Voltage	20	V
VGSS	Gate-Source Voltage	±12	V
ID@TA=25°C	Continuous Drain Current, VGS @ 4.5V	60	A
ID@TA=70°C	Continuous Drain Current, VGS @ 4.5V	39	A
IDM	Pulsed Drain Current ^{note1}	200	A
EAS	Single Pulsed Avalanche Energy ^{note2}	47.6	mJ
PD@TA=25°C	Power Dissipation	37	W
TJ, TSTG	Operating and Storage Temperature Range	-55 to +175	°C
RθJA	Thermal Resistance Junction-Ambient ¹	25	°C/W
RθJC	Thermal Resistance, Junction to Case	4	°C/W

Electrical Characteristics (T_c=25°C, unless otherwise noted)

Symbol	Parameter	Test Condition	Min.	Typ.	Max.	Units
V(BR)DSS	Drain-Source Breakdown Voltage	VGS=0V, ID=250μA	20	24	-	V
IDSS	Zero Gate Voltage Drain Current	VDS=20V, VGS=0V,	-	-	1.0	μA
IGSS	Gate to Body Leakage Current	VDS=0V, VGS=±12V	-	-	±100	nA
VGS(th)	Gate Threshold Voltage	VDS=VGS, ID=250μA	0.5	0.7	1.2	V
RDS(on)	Static Drain-Source on-Resistance note3	VGS=4.5V, ID=30A	-	4.8	6.5	mΩ
		VGS=2.5V, ID=20A	-	8.2	10	
Ciss	Input Capacitance	VDS=10V, VGS=0V, f = 1.0MHz	-	1832	-	pF
Coss	Output Capacitance		-	289	-	pF
Crss	Reverse Transfer Capacitance		-	271	-	pF
Qg	Total Gate Charge	VDS=10V, ID=30A, VGS=4.5V	-	23	-	nC
Qgs	Gate-Source Charge		-	4.5	-	nC
Qgd	Gate-Drain("Miller") Charge		-	7.3	-	nC
td(on)	Turn-on Delay Time	VDS=10V, ID=30A, RGEN=3Ω, VGS =4.5V	-	15	-	ns
tr	Turn-on Rise Time		-	37	-	ns
td(off)	Turn-off Delay Time		-	52	-	ns
tf	Turn-off Fall Time		-	21	-	ns
IS	Maximum Continuous Drain to Source Diode Forward Current		-	-	60	A
ISM	Maximum Pulsed Drain to Source Diode Forward Current		-	-	210	A
VSD	Drain to Source Diode Forward Voltage	VGS = 0V, IS=25A	-	-	1.2	V

Notes:

- 1 、 Repetitive Rating: Pulse Width Limited by Maximum Junction Temperature
- 2 、 The test condition is, VDD=10V, VG=4.5V, L=0.5mH, RG=25Ω, IAS=13.8A
- 3 、 The data tested by pulsed Pulse Test: Pulse Width≤300μs, Duty Cycle≤0.5%
- 4 、 The power dissipation is limited by 150 °C junction temperature

Typical Characteristics

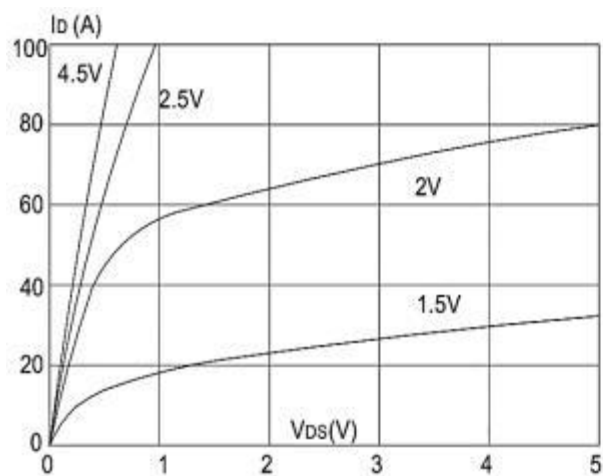


Figure 1: Output Characteristics

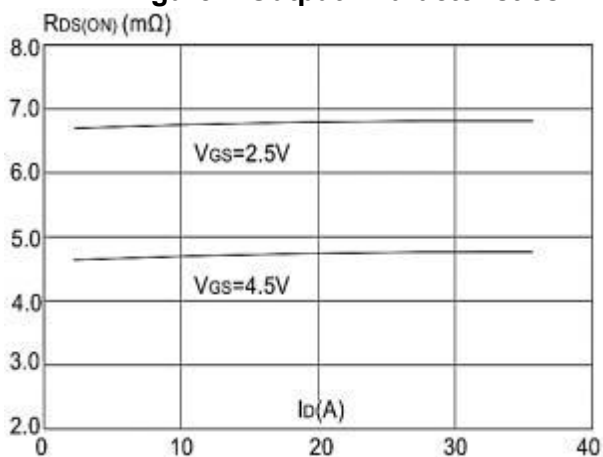


Figure 3: On-resistance vs. Drain Current

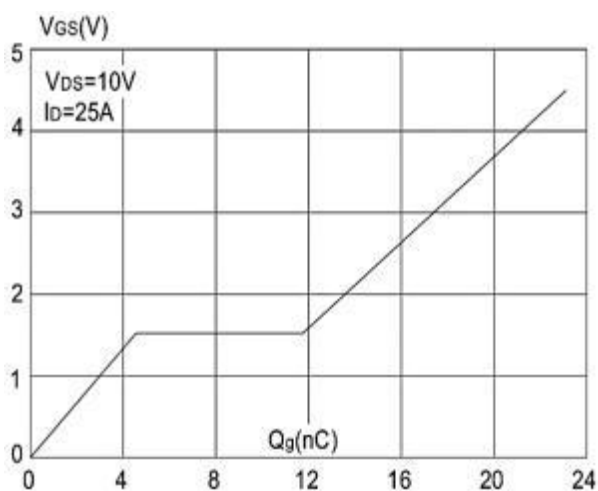


Figure 5: Gate Charge Characteristics

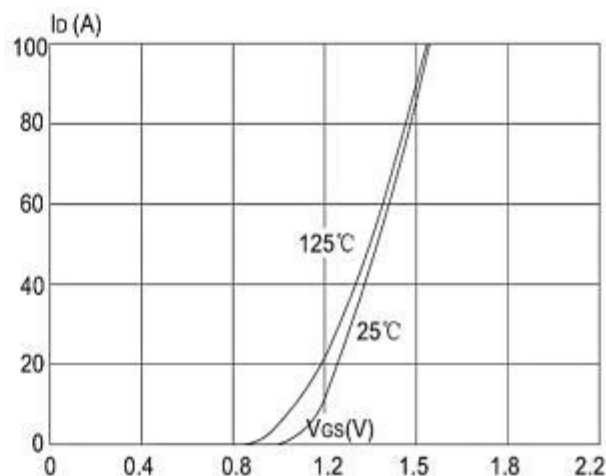


Figure 2: Typical Transfer Characteristics

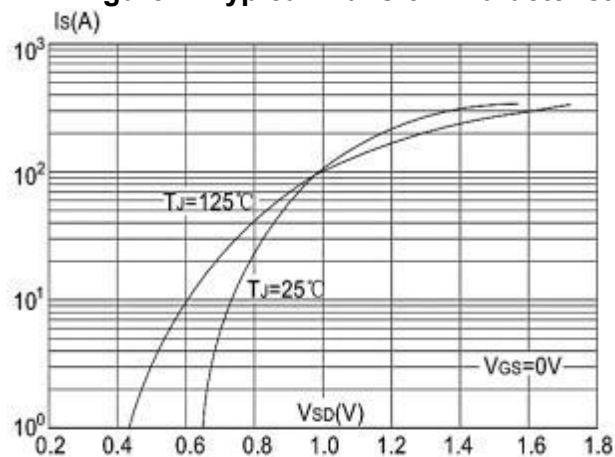


Figure 4: Body Diode Characteristics

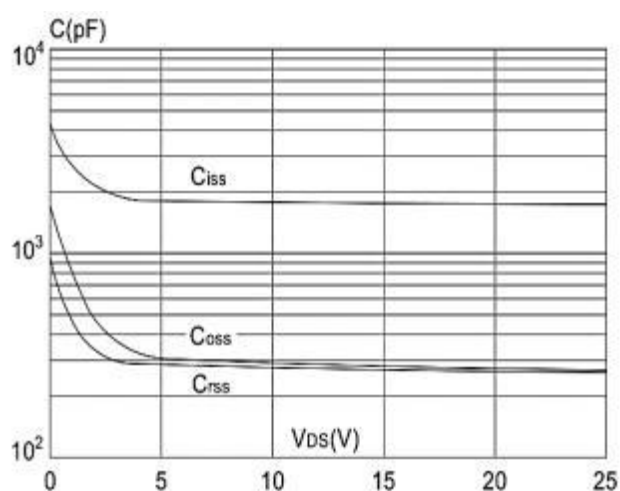


Figure 6: Capacitance Characteristics

Typical Characteristics

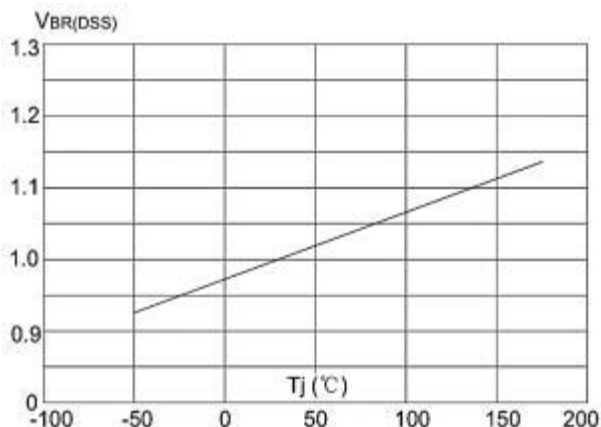


Figure 7: Normalized Breakdown Voltage vs. Junction Temperature

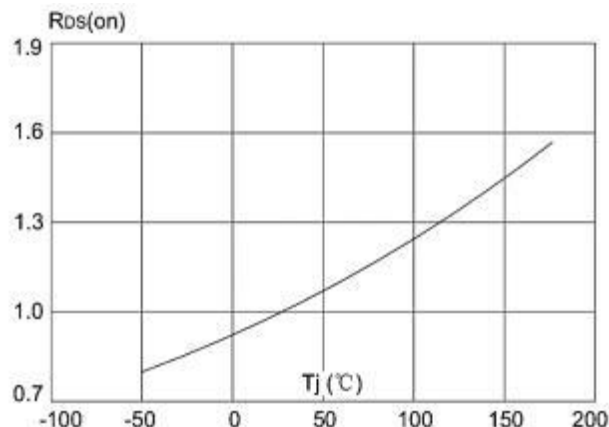


Figure 8: Normalized on Resistance vs. Junction Temperature

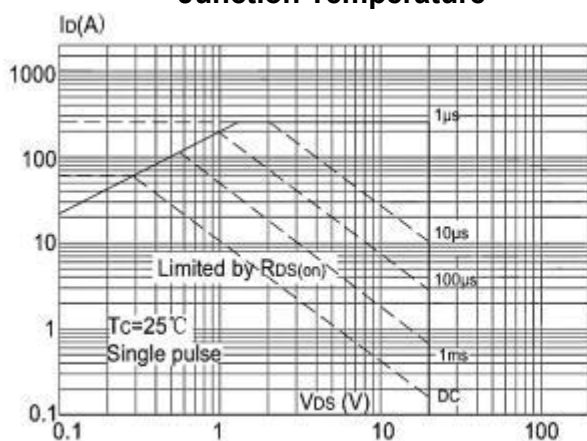


Figure 9: Maximum Safe Operating Area Temperature

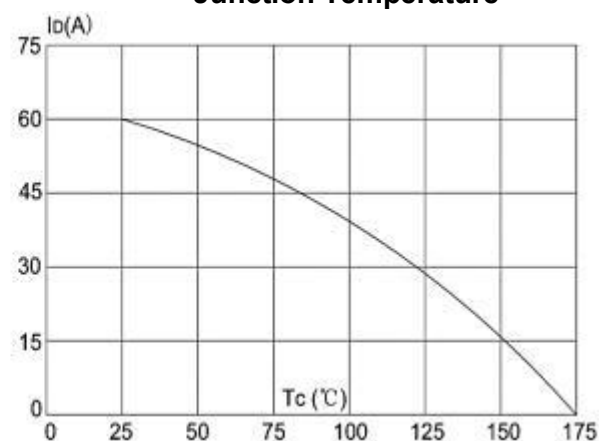


Figure 10: Maximum Continuous Drain Current vs. Case

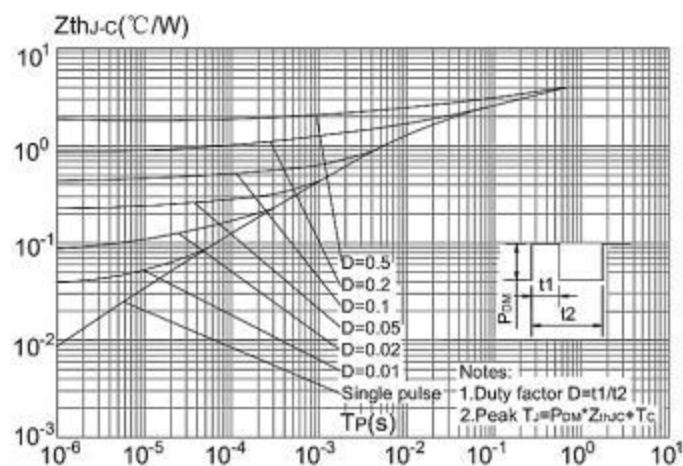
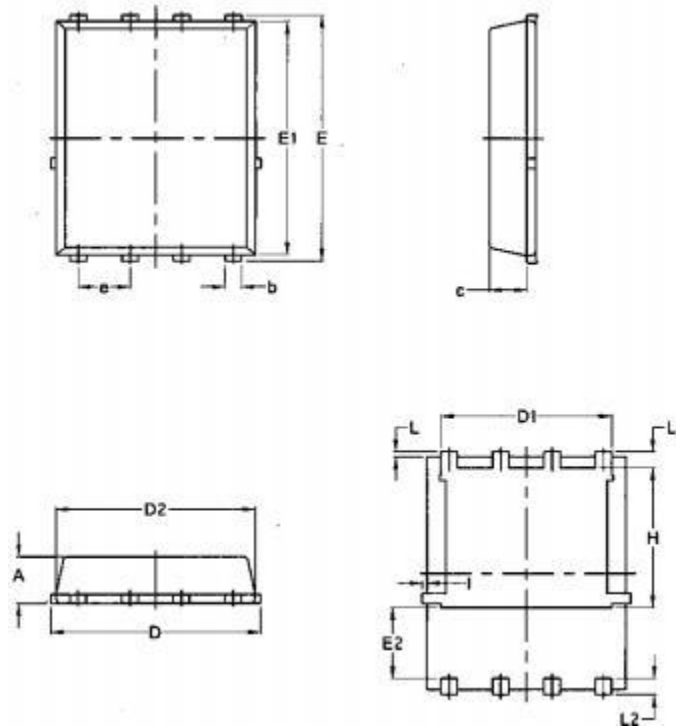


Figure.11: Maximum Effective Transient Thermal Impedance, Junction-to-Case

Package Mechanical Data-PDFN5*6-8L-JQ Single



Symbol	Common			
	mm		Inch	
	Mim	Max	Min	Max
A	1.03	1.17	0.0406	0.0461
b	0.34	0.48	0.0134	0.0189
c	0.824	0.0970	0.0324	0.082
D	4.80	5.40	0.1890	0.2126
D1	4.11	4.31	0.1618	0.1697
D2	4.80	5.00	0.1890	0.1969
E	5.95	6.15	0.2343	0.2421
E1	5.65	5.85	0.2224	0.2303
E2	1.60	/	0.0630	/
e	1.27 BSC		0.05 BSC	
L	0.05	0.25	0.0020	0.0098
L1	0.38	0.50	0.0150	0.0197
L2	0.38	0.50	0.0150	0.0197
H	3.30	3.50	0.1299	0.1378
I	/	0.18	/	0.0070

Package Marking and Ordering Information

Product ID	Pack	Marking	Qty(PCS)
TAPING	PDFN5*6-8L		5000